



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.: 09/848,932 Confirmation No.: 7101
First Named Inventor: Hoffman, Paul Filing Date: May 4, 2001
Group Art Unit: 2827 Examiner: Cruz, Lourdes C.
Atty. Docket No.: M-9954 US
Title: Shielded Semiconductor Package With Single-Sided Substrate And Method For Making The Same
Assignee: Amkor Technology, Inc.

San Francisco, California
January 13, 2003

BOX NON-FEE AMENDMENT
COMMISSIONER FOR PATENTS
Washington, D.C. 20231

**REQUEST TO AMEND DRAWINGS
UNDER 37 C.F.R. § 1.121**

Sir:

Pursuant to 37 C.F.R. § 1.121, Applicants respectfully request permission to amend Figs. 1, 5 and 6, as shown in red on the accompanying sheets.

If the Examiner has any questions concerning this request, the Examiner is invited to call the undersigned at (415) 217-6000.

EXPRESS MAIL LABEL NO:

EV 259 160 039 US

Respectfully submitted,

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